

1A, 50V - 1000V Glass Passivated Fast Recovery Rectifier

FEATURES

- Glass passivated chip junction
- High efficiency, Low V_F
- High current capability
- High reliability
- High surge current capability
- Low power loss
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS

PARAMETER	VALUE	UNIT
$I_{F(AV)}$	1	A
V_{RRM}	50 - 1000	V
I_{FSM}	30	A
$T_{J\ MAX}$	150	°C
Package	TS-1	
Configuration	Single Die	

APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer and telecommunication.



MECHANICAL DATA

- Case: TS-1
- Molding compound meets UL 94V-0 flammability rating
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.2 g (approximately)



TS-1

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	F1T1 G-K	F1T2 G-K	F1T3 G-K	F1T4 G-K	F1T5 G-K	F1T6 G-K	F1T7 G-K	UNIT
Marking code on the device		F1T1G	F1T2G	F1T3G	F1T4G	F1T5G	F1T6G	F1T7G	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Forward current	$I_{F(AV)}$	1							A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I_{FSM}	30							A
Junction temperature	T_J	- 55 to +150							°C
Storage temperature	T_{STG}	- 55 to +150							°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient thermal resistance	$R_{\theta JA}$	90	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾		I _F = 1A,T _J = 25°C	V _F	-	1.3	V
Reverse current @ rated V _R per diode ⁽²⁾		T _J = 25°C	I _R	-	5	μA
		T _J = 125°C		-	150	μA
Junction capacitance		1 MHz, V _R =4.0V	C _J	15	-	pF
Reverse recovery time	F1T1G-K	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	150	ns
	F1T2G-K					
	F1T3G-K					
	F1T4G-K					
	F1T5G-K			-	250	ns
	F1T6G-K			-	500	ns
	F1T7G-K					

Notes:

1. Pulse test with $PW = 0.3\text{ ms}$
2. Pulse test with $PW = 30\text{ ms}$

ORDERING INFORMATION

PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
F1TXG-K (Note 1, 2)	A0	G	TS-1	3,000 / Ammo box (52mm taping)
	A1		TS-1	3,000 / Ammo box (26mm taping)
	R0		TS-1	5,000 / 13" Paper reel
	B0		TS-1	1,000 / Bulk packing

Notes:

1. "x" defines voltage from 50V (F1T1G-K) to 1000V (F1T7G-K)
2. Whole series with green compound (halogen-free)

EXAMPLE P/N

EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
F1T1G-K A0G	F1T1G-K	A0	G	Green compound

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

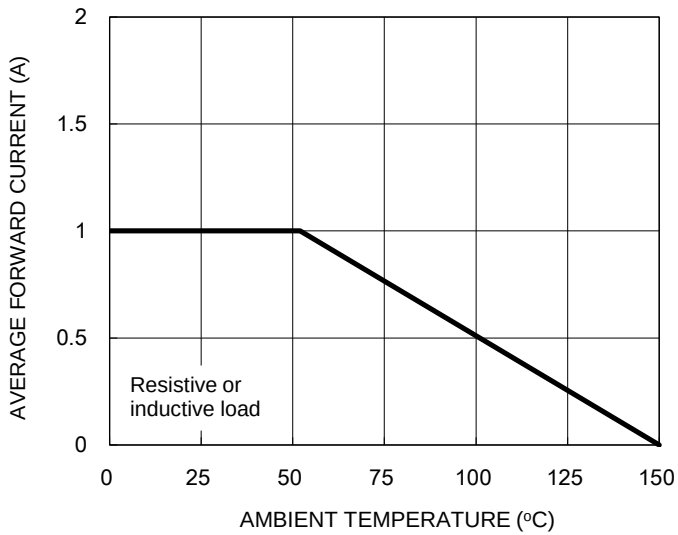


Fig.2 Typical Junction Capacitance

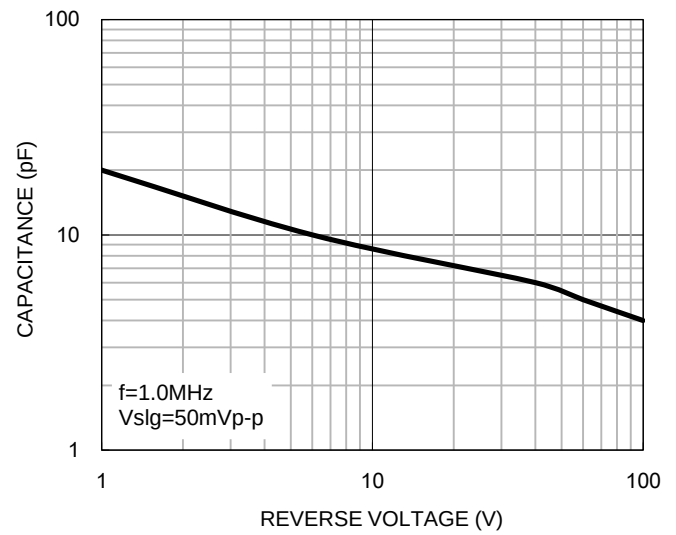


Fig.3 Typical Reverse Characteristics

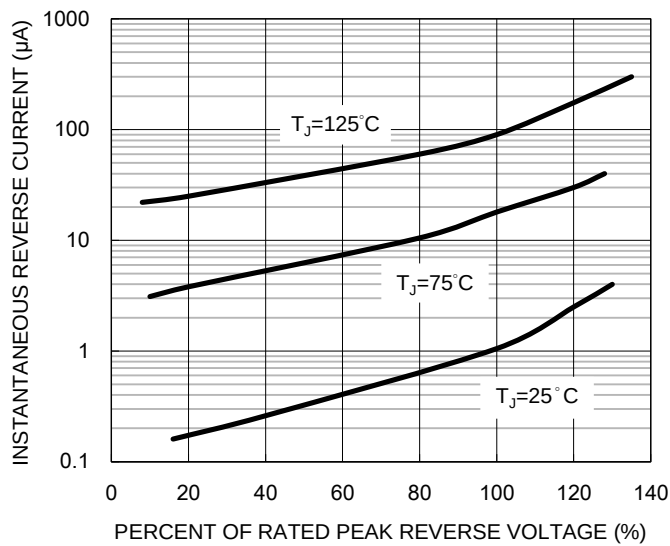
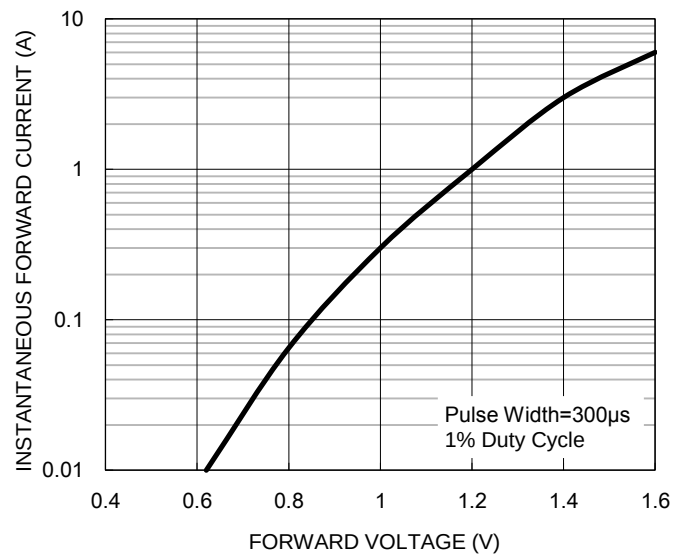


Fig.4 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

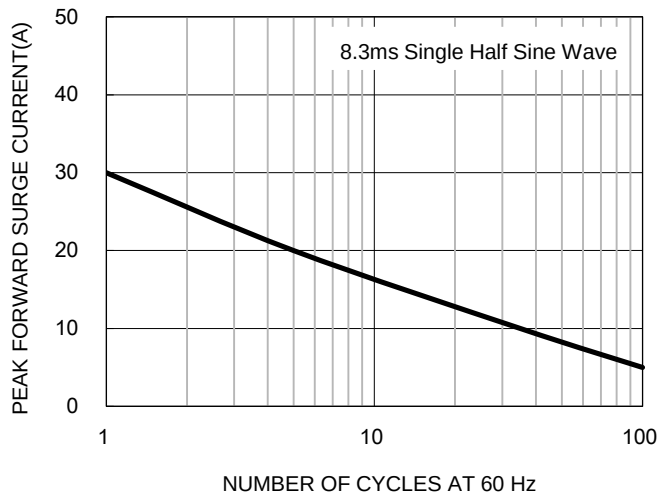
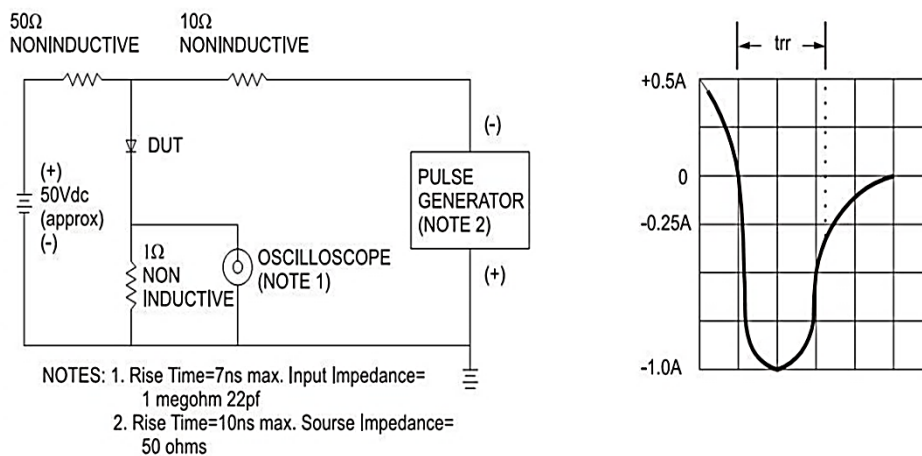
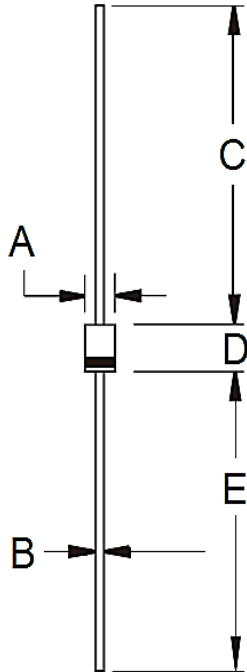


Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram



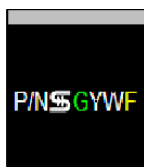
PACKAGE OUTLINE DIMENSIONS

TS-1



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	2.00	2.70	0.079	0.106
B	0.53	0.64	0.021	0.025
C	25.40	-	1.000	-
D	3.00	3.30	0.118	0.130
E	25.40	-	1.000	-

MARKING DIAGRAM



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code

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